# UTC UNISONIC TECHNOLOGIES CO., LTD

# UT90N03M

## **Preliminary**

#### **POWER MOSFET**

# 90A, 30V N-CHANNEL **ENHANCEMENT MODE** POWER MOSFET

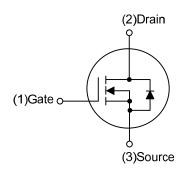
#### DESCRIPTION

The UTC UT90N03M is a N-channel power MOSFET providing very low on-resistance. It has high efficiency and perfect cost-effectiveness. It can be generally applied in the commercial and industrial fields.

#### **FEATURES**

- \*  $R_{DS(ON)} \le 4.5 \text{ m}\Omega$  @  $V_{GS}$  = 10V,  $I_D$  = 45A  $R_{DS(ON)} \le 5.5 \text{ m}\Omega$  @  $V_{GS} = 4.5V$ ,  $I_{D} = 30A$
- \* Improved dv/dt capability
- \* Simple drive requirement

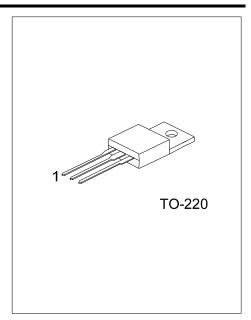




#### ORDERING INFORMATION

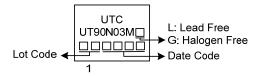
Ordering Number		Deelsene	Pin Assignment			Deelsing	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UT90N03ML-TA3-T UT90N03MG-TA3-T		TO-220	G	D	S	Tube	
Note: Pin Assignment: G: Gate D: Drain S: Source							

UT90N03MG-TA3-T (1) T: Tube - (1)Packing Type (2)Package Type (2) TA3: TO-220 (3) G: Halogen Free and Lead Free, L: Lead Free (3)Green Package



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### ■ MARKING



#### ■ ABSOLUTE MAXIMUM RATING (T<sub>C</sub>=25°C unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	30	V	
Gate-Source Voltage		$V_{GSS}$	±20	V	
Drain Current	DC	I <sub>D</sub>	90	Α	
	Pulsed (Note 2)	I <sub>DM</sub>	180	Α	
Avalanche Energy	Single Pulsed (Note 3)	E <sub>AS</sub>	49	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	1.44	V/ns	
Power Dissipation		$P_D$	220	W	
Junction Temperature		$T_J$	+150	°C	
Storage Temperature Range		T <sub>STG</sub>	-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 0.1mH,  $I_{AS}$  = 31.35A,  $V_{DD}$  = 50V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C
- 4.  $I_{SD} \leq 30 A$ ,  $di/dt \leq 200 A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_{J} \leq 25 ^{\circ} C$

#### ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT	
Junction to Ambient	$\theta_{JA}$	62.5	°C/W	
Junction to Case	θις	0.5	°C/W	

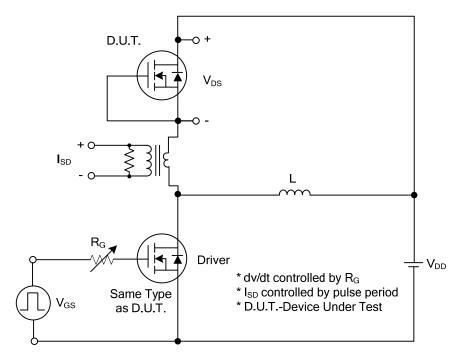
## ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30			V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V			1	μA
Forward	1	V <sub>GS</sub> =+20V, V <sub>DS</sub> =0V			+100	nA
Gate-Source Leakage Current Reverse	l <sub>GSS</sub>	V <sub>GS</sub> =-20V, V <sub>DS</sub> =0V			-100	nΑ
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> =250µA	1.0		3.0	V
Otatia Dunin Carres On Otata Daniatana	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =45A			4.5	mΩ
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =30A			5.5	mΩ
DYNAMIC PARAMETERS						
Input Capacitance	C <sub>ISS</sub>			3078		pF
Output Capacitance	Coss	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1.0MHz		580		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			512		pF
SWITCHING PARAMETERS			- a			
Total Gate Charge	$Q_G$	-\( -24\\ \\ -10\\ \   -004		103		nC
Gate to Source Charge	Q <sub>G</sub> s	V <sub>DS</sub> =24V, V <sub>GS</sub> =10V, I <sub>D</sub> =90A (Note 1, 2)		15		nC
Gate to Drain Charge	$Q_GD$	(Note 1, 2)		27		nC
Turn-ON Delay Time	t <sub>D(ON)</sub>			8		ns
Rise Time	t <sub>R</sub>	V <sub>DD</sub> =15V, V <sub>GS</sub> =10V, I <sub>D</sub> =90A,		18		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	R <sub>G</sub> =3.3Ω (Note 1, 2)		84		ns
Fall-Time	t⊧			58		ns
SOURCE-DRAIN DIODE RATINGS AND	CHARACTER	RISTICS				
Maximum Continuous Drain-Source Dioc	le Is				90	Α
Forward Current	15				90	
Maximum Pulsed Drain-Source Diode	Ism				180	Α
Forward Current	IOIVI				100	
Diode Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> =90A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time (Note 1)	t <sub>rr</sub>	Is=30A, V <sub>GS</sub> =0V,		295		nS
Reverse Recovery Charge	Qrr	dI <sub>F</sub> /dt =100A/μs		976		nC

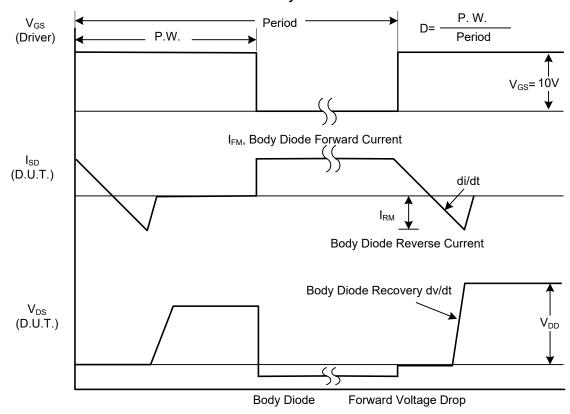
Notes: 1. Pulse Test: Pulse width  $\leq$  300 $\mu$ s, Duty cycle  $\leq$  2%.

<sup>2.</sup> Essentially independent of operating temperature.

#### TEST CIRCUITS AND WAVEFORMS

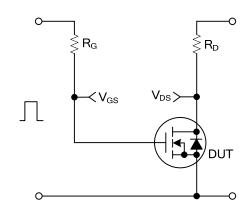


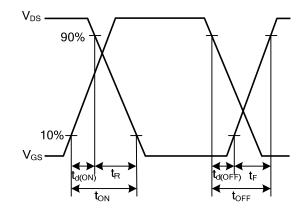
#### Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

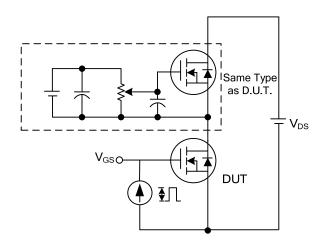
#### ■ TEST CIRCUITS AND WAVEFORMS

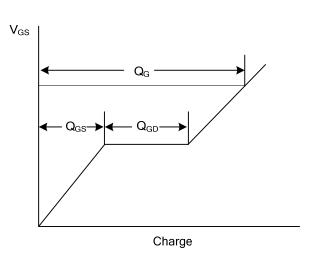




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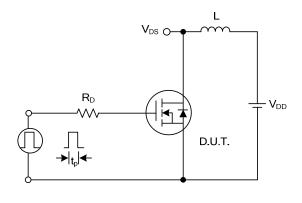
**Switching Waveforms** 

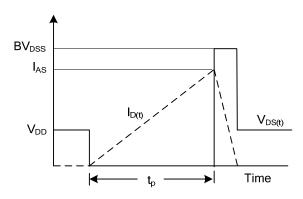




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

**Unclamped Inductive Switching Waveforms** 

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